Devcon HP 250

Epoxy; Epoxide

Devcon

Message:

High performance epoxy with high shear strength and impact toughness for structural assembly applications. Intended Use: Bonds metals, FRP/SMC composites,phenolics, stainless steel, aluminum, vinyl esters, nylon, PVC,PC,styrenics, wood, and rigid plastics.

Product Features: Non-corrosive/outstanding chemical resistance Excellent salt spray durability

General Information					
Features	Anti-salt water/fog				
	Impact resistance, high				
	Good chemical resistance				
	Non-corrosive				
Uses	Metal bonding				
	Bonding				
Physical	Nominal Value	Unit	Test Method		
Specific Volume	0.921	cm³/g			
Solid content-by Volume	100	%			
Impact Resistance	16.7	J			
Service Temperature	-55 - 121	°C			
Work Time (22°C)	1.1	hr			
Tensile Shear Adhesion	22.1	MPa	ASTM D1002		
Density ¹	1.08	g/cm³			
Hardness	Nominal Value	Unit	Test Method		
Durometer Hardness (Shore D)	78		ASTM D2240		
Mechanical	Nominal Value	Unit			
Tensile Elongation (Break)	25	%			
Electrical	Nominal Value	Unit	Test Method		
Dielectric Strength	19	kV/mm	ASTM D149		
Thermoset	Nominal Value	Unit	Test Method		
Thermoset Components					

Thermoset Components

Mixing ratio by weight: 100

Component B	Mixing ratio by capacity: 1.0		
Thermoset Mix Viscosity	105000	сР	
Additional Information	Nominal Value	Unit	Test Method
Cured 7 days @ 75°F			
Uncured Properties	Nominal Value	Unit	Test Method
Curing Time (22°C)	24	hr	
NOTE			
1.	Mixed		

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